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To the Honorable
Please record this

103598354

Remarks:
copy thereof.

1. Name of conveying party(ies):
Jong-Baek SEON,
Sang-Yoon LEE,
Jeong-il PARK,
Myung-Kwan RYU,
Kyung-Bae PARK
Additional name(s) of conveying party(ies) attached?
 YES NO

2. Name and address of receiving party(ies)
Name: Samsung Electronics Co., Ltd.
Street Address: 416, Maetan-dong,
Yeongtong-gu, Suwon-si
City: Gyeonggi-do
Country: Republic of Korea
Postal Code:

3. Nature of conveyance:
 Assignment Merger Security Agreement
 Change of Name Other: **correction**
Execution Date:
03-11-2010, 03-11-2010, 03-11-2010,
03-11-2010, 03-11-2010

Additional name(s) & address(es) attached? YES NO

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No(s).
12/656,682

B. Patent No.(s).

Additional numbers attached? YES NO

5. Name and address of party to whom
correspondence concerning document should be
mailed:
Name: **HARNES, DICKEY & PIERCE, P.L.C.**
Street Address: **P.O. BOX 8910**
City: **RESTON** State: **VA** ZIP: **20195**
Country: **USA**

6. Total No. of applications/patents involved: **One (1)**

7. Total fee (37 C.F.R. § 3.41): **\$40.00**

Enclosed
 Authorized to be charged to deposit account,
if no fee attached.

8. Deposit account number: 08-0750

(Attach triplicate copy of this page
if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

John A. Castellano/35,094
Name of Person Signing/Reg. No.

[Signature]
Signature

May 25, 2010
Date

Total number of pages including cover sheet, attachments, and document: three (3)

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01 FC:0021 40.00 OF



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03-23-2010

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To the Honor:
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Trademarks:
copy thereof.

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**Jong-Baek SEON, Sang-Yoon LEE,
Jong-il PARK, Myung-Kwan RYU,
Kyung-Bae PARK**

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

John A. Castellano/35,094
Name of Person Signing/Reg. No.

Signature

March 18, 2010
Date

Total number of pages including cover sheet, attachments, and document: three (3)



03/22/2010 MJAMA1 00000015 12656682
01 FC:0021

JAC/mk

40.00 DP

ASSIGNMENT

WHEREAS, the undersigned, hereinafter referred to collectively as Assignor, has invented:

**SOLUTION COMPOSITION AND METHOD OF FORMING THIN FILM AND
METHOD OF MANUFACTURING THIN FILM TRANSISTOR
USING THE SOLUTION COMPOSITION**

for which Assignor is about to make or has made United States or International application for patent

- (a) executed on even date preparatory to filing (each inventor should sign this Assignment on the same day as he/she signs the Declaration and Power of Attorney);
- (b) executed on _____, _____, _____; or
- (c) filed on February 12, 2010, and assigned Serial No. _____ or PCT International Application No. _____; and

WHEREAS, Samsung Electronics Co., Ltd., 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, hereinafter referred to as Assignee, is desirous of acquiring all right, title, and interest therein:

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy whereof is hereby acknowledged, Assignor agrees to, and hereby does, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the invention as described in the aforesaid application and all United States Letters Patent which may be granted therefore, and all divisions, continuations, reissues, reexaminations and extensions thereof, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications or patents resulting therefrom;

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

Assignor hereby covenants that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment; and

Assignor hereby requests the United States Patent and Trademark Office to issue the Letters Patent of the United States of America to Assignee, and requests that any official of any country or countries foreign to the United States, whose duty it is to issue or grant patents and applications as aforesaid, to issue the Letters Patent, Utility Model Registration or Inventor's Certificate to Assignee.

The undersigned hereby grant(s) the law firm of Harness, Dickey & Pierce, P.L.C. the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

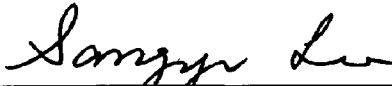
ASSIGNMENT



Jong-Baek SEON

March 11, 2010

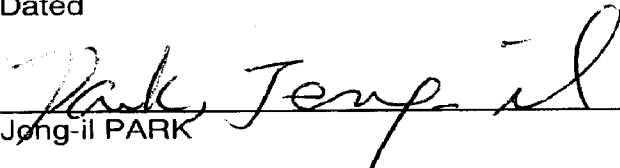
Dated



Sang-Yoon LEE

March 11, 2010

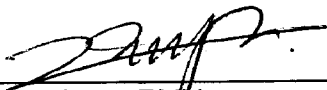
Dated



Jong-il PARK

March 11, 2010

Dated



Myung-Kwan RYU

March 11, 2010

Dated



Kyung-Bae PARK

March 11, 2010

Dated

